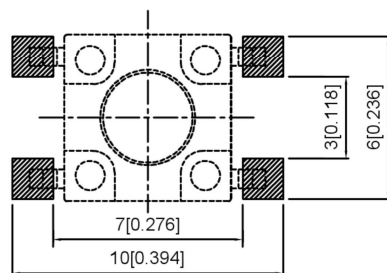
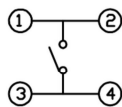


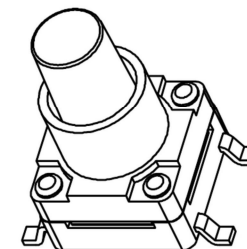
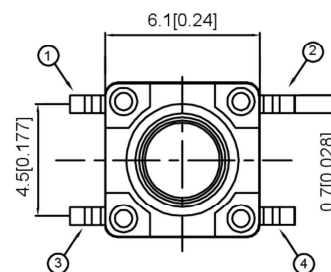
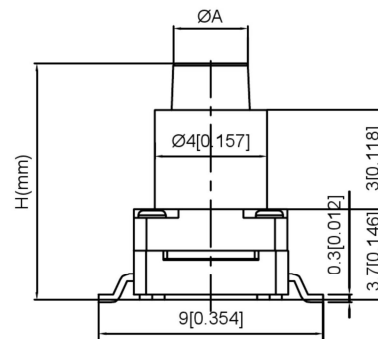
Code-x	H
A	4.3
B	4.5
C	5.0
D	5.5
E	6.0
F	6.5
G	7.0
H	7.5
I	8.0
J	8.5
K	9.0



PCB LAYOUT PLAN



CIRCUIT DIAGRAM



Code-X	H
L	9.5
M	10.0
N	10.5
O	11.0
P	11.5
Q	12
R	12.5
S	13.0
T	13.5
U	14.0
V	15.0
W	15.5
X	16
Y	16.5
Z	17
18	18
19	19

SPECIFICATION

Contact Rating: 50mA, 12V DC
 Contact Resistance: 100mΩ max
 Insulation Resistance: 100mΩ min. 500V DC
 Dielectric Strength: 250V AC/1minute
 Travel: 0.25mm
 Operating Temp: -30℃~+85℃
 Storage Temp: -30℃~+80℃

PAPT NO	TS-FS66T-X-X
Operating Force	A:100gf B:160gf C:260gf
Height	Code-x

⑤	Terminal	—	4	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	PPA		—
②	Cover	—	1	PPA		—
①	Keystake	—	1	PPA		—
ITEM	PAPT NAMF	TER.NO	QTY	MATERIAL	FINISHING	REMARK

				ANGULAR	±5°
				L ≤ 4	±0.2
				4 < L ≤ 16	±0.3
				16 < L ≤ 63	±0.4
	DATE	REVISED	APPROVED	L > 63	±0.5
					UNSPECIFIED TOLERANCES
www.alpsr.com www.gdxidz.com www.xbswitch.com					



DSND		SCALE: N/A	MODEL TYPE: TACT SWITCH
DWN		VIEW:	PART NO.: TS-CB1157-X-X
CHKD		UNIT: mm/in	DWG NO.:
APPD		SIZE: A4	
		WEIGHT	SHEET
		1/1	REVISIT
			A0

DONG GUAN XI BANG ELECTRONIC CO., LTD